

Maximum Ratings (@T_A = 25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RM} V _{RWM} V _R	85	V
RMS Reverse Voltage		V _{R(RMS)}	60	V
Forward Continuous Current (Note 5)		I _{FM}	215	mA
Repetitive Peak Forward Current		I _{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0ms @ t = 1.0s	I _{FSM}	4.0 1.0 0.5	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5) @T _A = 25°C	P _D	250	mW
Thermal Resistance Junction to Ambient Air (Note 5) @T _A = 25°C	R _{ÐJA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

$\textbf{Electrical Characteristics} \ (@T_A = 25^{\circ}C, \ unless \ otherwise \ specified.)$

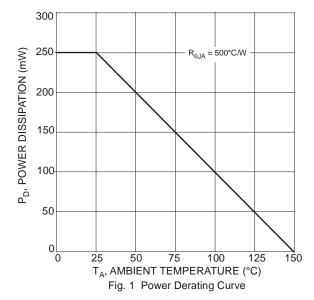
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	85	_		V	$I_R = 100\mu A$
Forward Voltage	V _F	_	_	0.90 1.0 1.1 1.25	>	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Leakage Current (Note 6)	I _R	_	_	5.0 80	nA nA	$V_R = 75V$ $V_R = 75V$, $T_j = 150$ °C
Total Capacitance	Ст	_	2	_	pF	$V_R = 0$, $f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_	_	3.0	μs	$\begin{split} I_F &= I_R = 10 \text{mA}, \\ I_{rr} &= 0.1 \times I_R, \ R_L = 100 \Omega \end{split}$

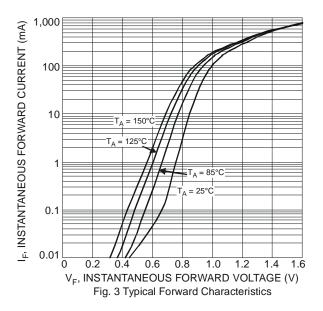
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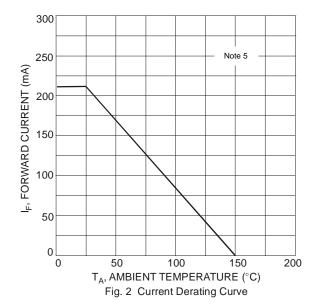
Notes:

^{5.} Part mounted on FR-4, 2oz 1inch squared copper pad PC board.6. Short duration pulse test used to minimize self-heating effect.









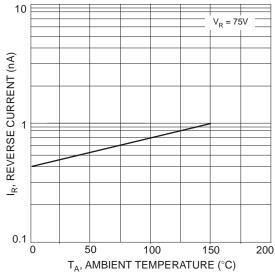


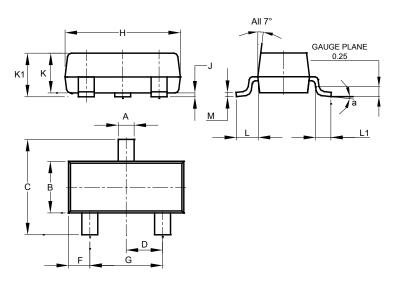
Fig. 4 Typical Reverse Characteristics



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

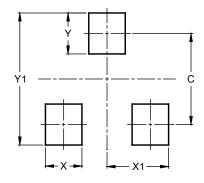


SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
7	0.013	0.10	0.05		
K	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
М	0.085	0.150	0.110		
а	0°	8°			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Υ	0.9
Y1	29

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